



UEC5-019-2-X-D-RA-1





UEC5, UCC8 SERIES

RUGGED MICRO FLYOVER™ SOCKET SYSTEM

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?UEC5-1 or www.samtec.com?UEC5-2

Insulator Material:

Black LCP Contact Material: BeCu Plating: Au or Sn over 50 μ" (1.27 μm) Ni Current Rating: 1.8 A per pin

Operating Temp Range: -55° C to +125° C RoHS Compliant: Yes

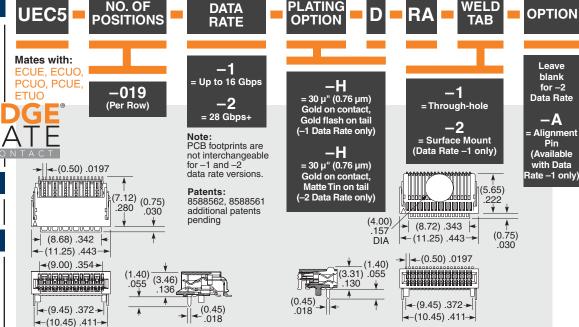
PROCESSING

Lead-Free Solderable: Yes SMT Lead Coplanarity: (0.10 mm) .004" max

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality

Note: Some lengths, styles and options are non-standard, non-returnable.



UEC5-019-1-X-D-RA-1-A

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?UCC8

Insulator Material: Black LCP Contact Material: BeCu Weld Tab:

Copper Alloy Plating: Au or Sn over 50 μ" (1.27 μm) Ni Current Rating: 2.6 A per pin (1 pin powered)

Operating Temp Range: -55° C to +125° C RoHS Compliant: Yes

PROCESSING

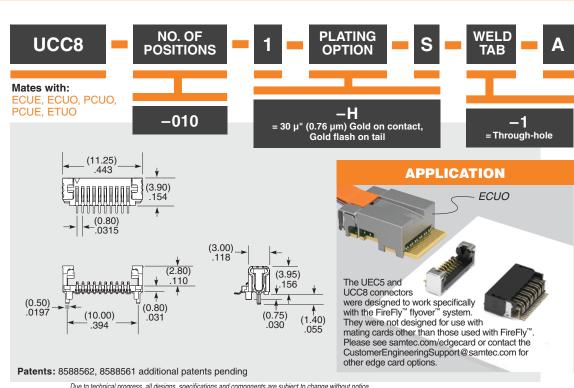
Lead-Free Solderable: Yes SMT Lead Coplanarity: (0.10 mm) .004" max

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



Note: Some lengths, styles and options are non-standard, non-returnable.



Due to technical progress, all designs, specifications and components are subject to change without notice WWW.SAMTEC.COM